



DATE: 19th Jan, 2016

PCN #: 2219

PCN Title: Additional FAB Source (TPSCo) and BOM (Bill of Materials) on select devices in SOT25 and MSOP8 packages

Dear Customer:

This is an announcement of change(s) to products that are currently being offered by Diodes Incorporated.

We request that you acknowledge receipt of this notification within 30 days of the date of this PCN. If you require samples for evaluation purposes, please make a request within 30 days as well. Otherwise, samples may not be built prior to this change. Please refer to the implementation date of this change as it is stated in the attached PCN form. Please contact your local Diodes sales representative to acknowledge receipt of this PCN and for any sample requests.

The changes announced in this PCN will not be implemented earlier than 45 days from the notification date stated in the attached PCN form.

Previously agreed upon customer specific change process requirements or device specific requirements will be addressed separately.

For questions or clarification regarding this PCN, please contact your local Diodes sales representative.

Sincerely,

Diodes Incorporated PCN Team



PRODUCT CHANGE NOTICE

PCN-2219 REV 00

Notification Date:	Implementation Date:	Product Family:	Change Type:	PCN #:
19 th Jan, 2016	29 th Feb, 2016	Analog Semiconductors	Additional Fab Source and BOM	2219
TITLE				
Additional FAB Source (TPSCo) and BOM (Bill of Materials) on select devices in SOT25 and MSOP8 packages				
DESCRIPTION OF CHANGE				
This PCN is being issued to notify customers that in order to assure continuity of supply, Diodes has qualified additional wafer fab source (TPSCo) TowerJazz Panasonic Semiconductor Co., Ltd. located in Japan and BOM (Bill of Materials) on selected devices manufactured at (SAT) Diodes Incorporated / Shanghai Assembly/Test, China. Full electrical characterization and high reliability testing has been completed on representative part numbers to ensure there is no change to device functionality or electrical specifications in the datasheet.				
IMPACT				
Continuity of Supply. No change in datasheet parameters and product performance.				
PRODUCTS AFFECTED				
Table 1 Qualification of additional fab source (TPSCo) and BOM - Lead frame, die attach (Hysol 8008MD) for SOT25 package				
Table 2 Qualification of additional fab source (TPSCo) and BOM - Lead frame, die attach (84-1LMISR4), wire type (0.8 mil Cu) and mold compound (CEL1700HF40SK-D3) for MSOP8 package				
Table 3 Qualification of additional fab source (TPSCo)				
WEB LINKS				
Manufacturer's Notice:	http://www.diodes.com/quality/pcns			
For More Information Contact:	http://www.diodes.com/contacts			
Data Sheet:	http://www.diodes.com/products			
DISCLAIMER				
Unless a Diodes Incorporated Sales representative is contacted in writing within 30 days of the posting of this notice, all changes described in this announcement are considered approved.				

Table 1 - Qualify Additional Fab Source and BOM for SOT25

AL8805W5-7	AL8807W5-7	AL8807AW5-7	
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Table 2 -Qualify Additional Fab Source and BOM for MSOP8

AL8806MP8-13	AL8807MP-13	AL8807AMP-13	
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Table 3 - Qualify Additional Fab Source

AL8807BMP-13	
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